Tektronix, Inc.

P.O. BOX 500 Beaverton,Oregon USA 97077 80009

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DRAFTING STANDARD

SYMBOLS AND PRACTICES FOR SCHEMATIC DIAGRAM DRAFTING OF ELECTRONIC CIRCUITS

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Issued By
TECHNICAL STANDARDS

Tektronix, Inc.

P.O. BOX 500 Beaverton,Oregon USA 97077 80009

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DRAFTING STANDARD

SYMBOLS AND PRACTICES FOR SCHEMATIC DIAGRAM DRAFTING OF ELECTRONIC CIRCUITS

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Part I. Use and Contents of Standard. This standard was developed into two sections, Part I and Part II. Part I explains the use and contents of the standard. Part II deals primarily with the graphic symbols.

1. PURPOSE.

The purpose of this standard is to establish selected standards for use by Tektronix, Inc. These standards identify Reference Designations and Graphic Symbols to be used in documentation of electrical and electronic parts and equipment.

SCOPE.

This Tektronix Standard is intended for use as a ready reference for the drafting of electrical and electronic schematic diagrams, in conjunction with ANSI Y32.2-1975. It is not intended to replace the national standard at Tektronix. This standard includes the most frequently used symbols from ANSI Y32.2-1975, plus symbols that have been devised for use by Tektronix that are not included in the ANSI standard. Also, in some cases some symbols from the ANSI standard were not included for Tektronix use; these cases are specifically noted in this standard. Symbols used in this standard that differ from ANSI are identified by "Tek", denoting that the symbol is used by Tektronix and not necessarily by any other organization.

APPLICABLE DOCUMENTS.

3.1 SOURCE DOCUMENTS.

ANSI Y32.16(R-1975) Reference Designations for Electrical and Electronic Parts and Equipment. This standard is also identified as Institute of Electrical and Electronic Engineers (IEEE) Standard 200.

ANSI Y32.2-1975 Graphic Symbols for Electrical and Electronic Diagrams.

This standard is also designated as IEEE Standard 315, and Canadian Standards Association (CSA) Z99.

ANSI Y14.15(R-1973) Electrical and Electronic Diagrams.

ANSI Y1.1-1972 Abbreviations for Use on Drawings and in Text.

3.2 REFERENCE DOCUMENTS.

ANSI Y10.5-1968 Letter Symbols for Quantities Used in Electrical Science and Electrical Engineering.

062-1874-00 Line Conventions and Lettering.

ANSI Y10.19-1969 Letter Symbols for Units Used in Science and Technology.

4. AUTHORITY FOR CHANGE.

Except for minor changes, revisions to this standard shall be approved by a consensus of the Ad Hoc committee that consists of a representative from each manuals group within Tektronix, Inc., and are to be implemented only by the Technical Standards Group.

5. APPLICATION.

The foregoing referenced documents are for use throughout the company. Before using a particular document, verify from Technical Standards that it is the latest edition, since the reference document current at the date of the subject drawing or text will be considered the control document.

6. SYMBOL SIZE

The symbols depicted in this standard are actual size for use on C-size drawings. Drawings larger than than C-size should not be used unless unavoidable (Drawings are reduced and filmed on microfiche for storage, and reproducibility of details is compromised if the drawing is not C-size). These symbols were drawn by use

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|------------|-------------|-----|------|----|
| 31Ju178 | 062-2476-00 | | 4 | 33 |

of 062-1193-00, Tektronix, Inc., drafting template.

7. LETTERING.

The lettering used in Part II of this standard is typeset. It is recommended, however, that all lettering on diagrams be hand-lettered, using the guidelines that appear in this standard, except when machine-drawn.

062-2476-00

Part II. Symbols

DIAGRAM FORMAT

The following guidelines have been adopted as a standard in the preparation of Tektronix schematic diagrams.

- 1. The diagram must have an issue symbol located along the bottom of the diagram near the center. There will be only one issue symbol per pullout page.
- 2. The manual title (same as in the text running head) should appear on each diagram and be located in the lower left hand corner. For those groups that put the circuit board part number (670-XXXX-XX) on the diagram, ensure that the 670-number appears on all diagrams.
 - 3. Diagram numbering:
 - a. Each diagram is sequentially numbered; do not use letter suffixes to identify diagrams, (e.g., or 1) A).
 - b. When new diagrams must be added to current manuals because of a circuit board change, the added diagram may have the same number as the existing diagram and the different board versions will be identified by the circuit board part number or serial number. The latest version of the diagram should appear first in the diagram sequence.
- 4. Notes should be located in one central location on the diagram, preferably, the lower right corner of the diagram.
- 5. Footnotes on diagrams and illustrations should be denoted by a symbol. The symbol sequence is as follows: (*) asterisk, (†) dagger, (‡) double dagger, and (§) section mark; if more than four footnotes are necessary, start over by using two asterisks, two single daggers, etc.
 - 6. The circuit board outline should be inked on the diagram with a number 4 or 6 rapidograph pen.
- 7. Function blocks will be inked on the same overlay as history information with a number 4 or 6 rapidograph pen. Use the long broken line and do not run through the component or circuit number. These will be shot at 50% black.
- 8. History information is put on an overlay and shot in photography at 50% black. When the part number for a component is changed, the component designator for that component is boxed by drawing a box on the overlay that encloses the circuit number. When any of the circuitry on a diagram is deleted, the circuitry is drawn on the overlay in its former configuration. The following note appears on the overlay: SEE PARTS LIST FOR EARLIER VALUES AND SERIAL NUMBER RANGES OF PARTS OUTLINED OR DEPICTED IN GRAY.
 - 9. Do not put the part number for a component on the diagram.
- 10. Referencing of signal lines—reference all signal lines to the circuit number, pin number, and diagram, (e.g., DELAY to U155-3 6).

- 11. Use the oval for showing voltages on the diagram. To be drawn on the diagram with a pencil. Example: $\boxed{-3.2 \text{ V}}$.
- 12. A hexagon enclosing a numeral is used to reference waveforms to the test points on the diagrams, e.g., $\langle 4 \rangle$.
 - 13. Electrical components shown on the diagrams are in the following units unless noted otherwise:
 - a. Capacitors: Values one or greater are in picofarads (pF). Values less than one are in microfarads (μ F).
 - b. Resistors: Ohms (Ω) .

DIAGRAM SIZE

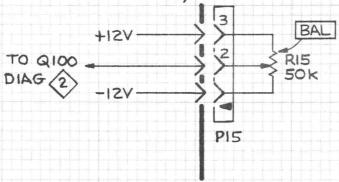
The finished diagram size is approximately 10 x 15 inches.

- 1. "C" Size (17 x 22): 59% reduction; minimum line spacing is 1/10; minimum letter size is 1/10.
- 2. "D" Size (22 x 34): 44% reduction; minimum line spacing is 0.15 (1 and 1/2 squares on a 10 x 10 grid); minimum letter size is 0.12 (1 and 2/10 squares on a 10 x 10 grid, or 1/8 inch).

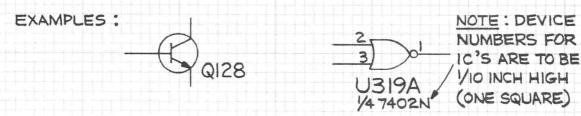
LETTERING SIZES FOR SCHEMATIC DIAGRAMS

All notes, values, and circuit numbers except transistors, integrated circuits, and schematic titles are to be 1/10 inch high, as shown in this sample. Each square of 10 x 10 grid paper is 1/10 inch high. The Tektronix Schematic Drafting Template (Tektronix Part Number 002-1193-00) is scaled for use on 10 x 10 grid paper up to "C" size drawing (17 x 22 inches). If a schematic must be drawn larger than a "C" size, these standards may not be applicable because of the larger reduction percentage necessary to print the diagram on a manual pullout page.

EXAMPLES OF SIZES FOR NOTES, VALUES AND CIRCUIT NUMBERS :

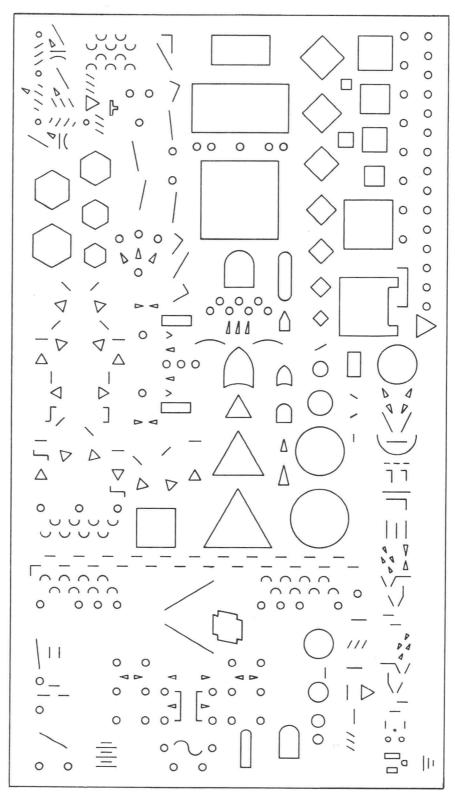


CIRCUIT NUMBERS FOR TRANSISTORS AND INTEGRATED CIRCUITS SHOULD BE 1 1/2 SQUARES HIGH.



SCHEMATIC TITLES ARE TO BE 2/10 INCH (2 SQUARES HIGH ON 10 × 10 GRID PAPER).

EXAMPLE: VERTICAL AMPLIFIER (2)



002-1193-00

CLASS DESIGNATION LETTERS MOST COMMONLY USED AT TEKTRONIX

NOTE:

IF A PART SERVES A PURPOSE OTHER THAN ITS GENERALLY INTENDED ONE, THE FUNCTION ACTUALLY PERFORMED WILL BE REPRESENTED BY THE GRAPHIC SYMBOL USED IN THE SCHEMATIC DIAGRAM.

EXAMPLES:

A LAMP USED AS A RESISTOR WOULD BE REPRESENTED BY THE GRAPHIC SYMBOL FOR A RESISTOR BUT THE LETTER CLASS WOULD BE 'DS'. A FOUR INPUT LOGIC GATE WHOSE INPUTS ARE TIED TOGETHER WOULD BE REPRESENTED BY AN INVERTER SYMBOL.

A —separable assembly separable subassembly

The class letter A is assigned on the basis that the item is separable. The class letter U shall be used if the item is inseparable.

For economic reasons, assemblies which are fundamentally separable may not be so provisioned but may be supplied as complete assemblies. However, the class letter A shall be retained.

- AR —amplifier (other than rotating)
- AT -fixed attenuator
- B —blower motor synchro
- BT —battery battery cell
- C —capacitor bushing capacitor
- CR —asymmetrical varistor
 crystal diode
 current regulator (semiconductor device)
 diode (semiconductor type)
 diode rectifier (semiconductor type)
 metallic rectifier
 photodiode (photosensitive type)
 thyristor (semiconductor diode type)
 varactor

- D —breakdown diode (voltage regulator) overvoltage absorber
- DC —directional coupler
- DL —delay function delay line
- DS —alphanumeric display device
 general light source
 indicator (excluding meter or thermometer)
 lamp (excluding heating lamp)
 light-emitting solid-state device
 photodiode (photoemissive type)
 signal light
 visual alarm
 visual indicator
 visual signaling device
- E —electrical shield ferrite bead rings Hall element ignitor gap spark gap
- F —current limiter (for power cable) fuse fuse cutout
- FL -filter
- G —electronic chopper generator
- HR —heater heating lamp heating resistor
- J jack receptacle (connector, stationary portion)
- K —contactor (magnetically operated)
- L —coil (all not classified as transformers) inductor
- LS —audible signaling device electric bell
- M -meter
- P —plug (connector, movable portion)
- PS -power supply

- Q —semiconductor controlled rectifier semiconductor controlled switch phototransistor (3 terminal) transistor
- R —function potentiometer potentiometer resistor rheostat
- RT —ballast lamp current-regulating resistor resistance lamp thermal resistor thermistor
- RV —symmetrical varistor voltage-sensitive resistor
- S —contactor (manually, mechanically, or thermally operated)
 disconnecting device (switch)
 electrical safety interlock
 flasher (circuit interrupter)
 switch
 thermal cutout (circuit interrupter) (not visual)
- SQ -fusible link
- T -transformer
- TB —connecting strip terminal board terminal strip test block
- TC —semiconductor thermocouple thermocouple
- TP -test point
- U —inseparable assembly integrated-circuit package microcircuit micromodule photon-coupled isolator
- V -electron tube
- VR —induction voltage regulator voltage regulator (excluding electron tube)

- W —wire strap
 dummy resistor
 cable
 cable assembly (with connectors)
 coaxial cable
 conductor
 wire
- Z —phase shifter phase-changing network resonator (tuned cavity)

For Class Designation letters of items not listed, refer to ANSI Y32.2

| - | | | | | | · | | | |
|--------|-----|-----|-----|-----|-----|----|----------|---|----|
| \sim | | AI | IEV | | SYN | | Δ | 0 | -0 |
| 8.4 | 1.1 | AAL | | ING | 211 | an | C)I | 3 | - |

Qualifying symbols are to be used with the basic symbol to indicate a special property.

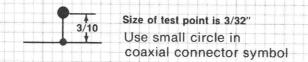
Adjustability 1.1

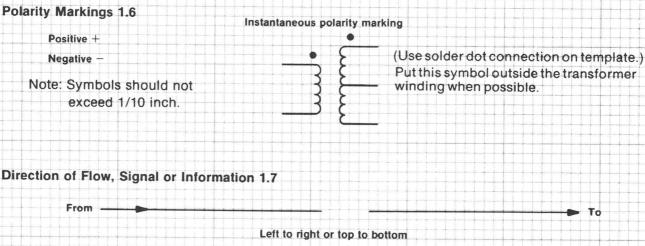
All screwdriver adjustments will have \bigcirc symbol on schematic.

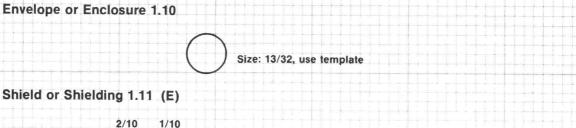
Each adjustment on the schematic should have its purpose indicated by a title.

TEK INTENSITY GAIN (TEK TEK Panel Knob Panel Screwdriver Internal Screwdriver

Test Point Recognition 1.5 (TP)







PAGE OF PART NUMBER 062-2476-00

GRAPHIC SYMBOLS 2.

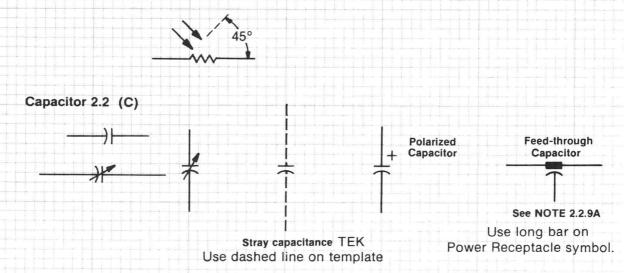
Resistors 2.1 (R)

Note: CW indicates position of adjustable contact at the limit of clockwise travel viewed from knob or actuator end.

Thermistor 2.1.12.1 (RT)

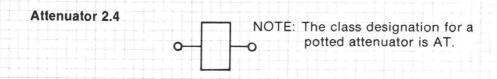


Symmetrical Photoconductive Transducer (Resistive) 2.1. 13 (R)



NOTE: The curved element represents:

- 1. The outside electrode in fixed paper dielectric and ceramic dielectric capacitors.
- 2. The moving elements in adjustable and variable capacitors.
- 3. The low potential element in feed-through capacitors.
- 4. The negative side of a polarized capacitor.

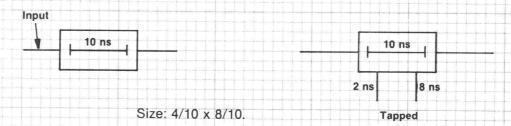


Battery 2.5 (BT)

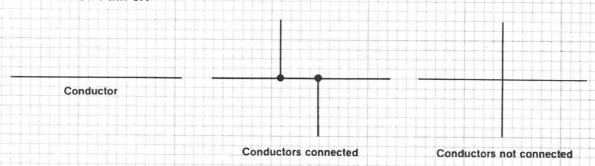


NOTE: List nominal voltage for batteries on diagrams.

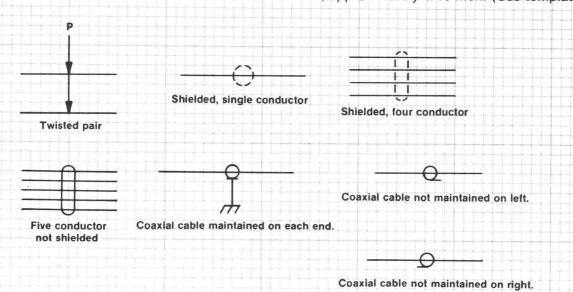
Delay Line 2.6 (DL)



Transmission Path 3.1



NOTE: All solder dots should be of the same size, approximately 1/16 inch. (Use template).

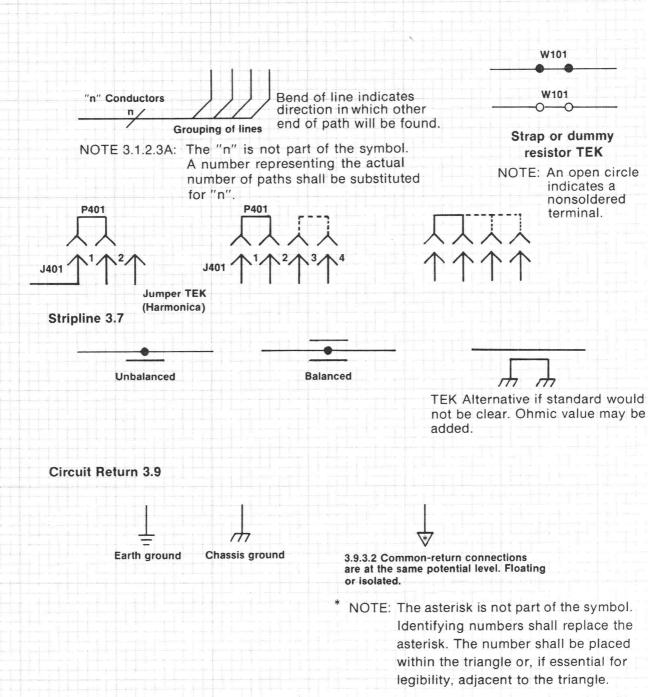


NOTE 3.1.9A: If necessary for clarity, an outer-conductor connection shall be made to the symbol.

NOTE 3.1.9B: If the coaxial structure is not maintained, the tangential line shall be drawn only on the coaxial side.

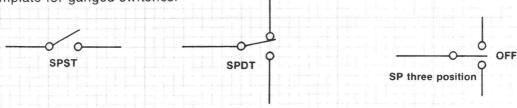
PAGE OF

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Switches 4.1

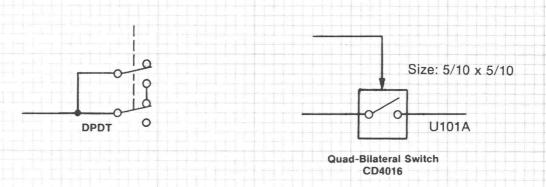
The standard method of showing switches is in a position with no operating force applied. Show self-cancelling switches in the most common position. Use the dashed line on the template for ganged switches.



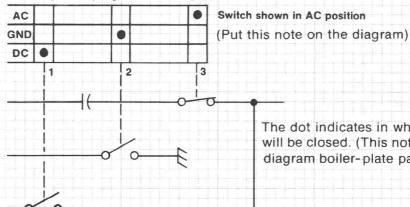
PAGE OF

PART NUMBER

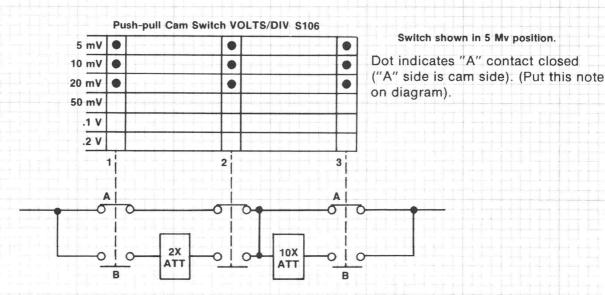
REV



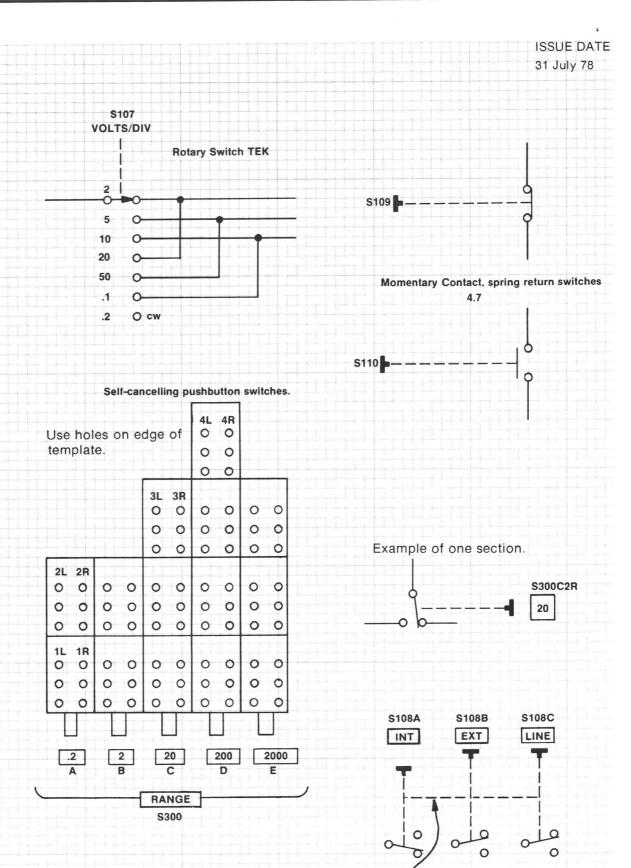
Vertical Input Coupling Cam Switch \$105



The dot indicates in what position the switch will be closed. (This note belongs on the diagram boiler-plate page).



Note to draftsperson: When A contact opens, B contact closes.



33

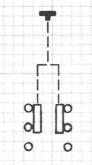
18

S114

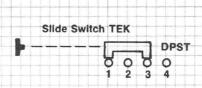
Safety Interlock

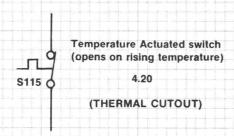
4.15

Indicates self cancelling

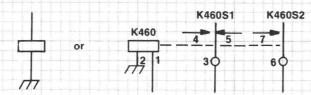


Slide Switch TEK





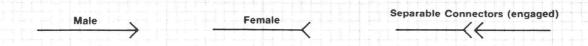
Relays 4.30



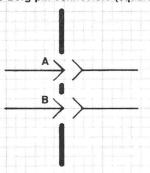
(SHOW IN THE NON-ENERGIZED POSITION)

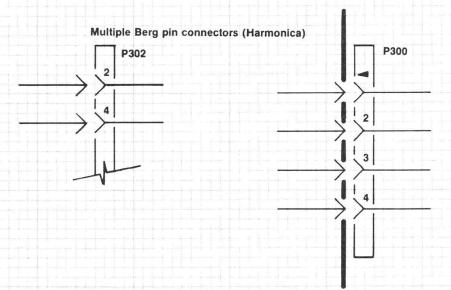
Connector 5.3

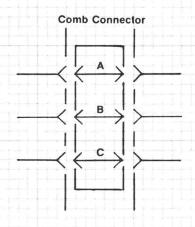
- 1. The most stationary portion of the connector is designated J.
- 2. The most movable portion of the connector is designated P. (Some circuit boards at Tektronix may have a P silkscreened on the circuit board, this is to indicate the attachment point for the designated connector (e.g. harmonica.)
- 3. If two cables are to be connected to each other, each of the mating cable connectors shall be designated P . ANSI Y32.16-1975 4.1.5.3 (4)

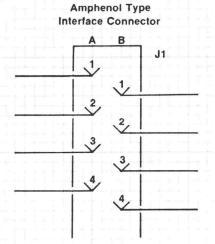


Single Berg pin connectors (square pin)

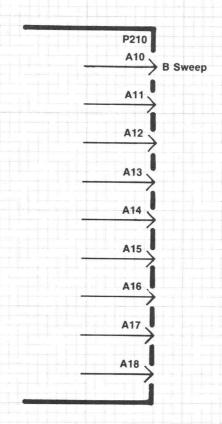


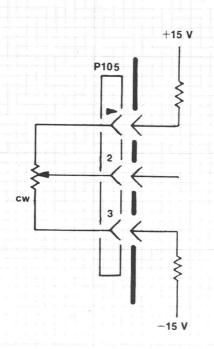






Edgeboard Connectors

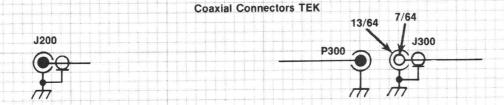




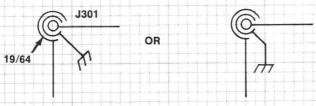
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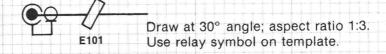
REV



Probe Coding TEK



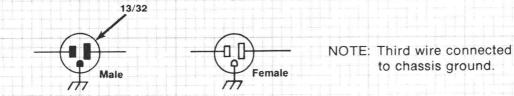
Ferrite Bead on Coaxial Cable 15.18.1



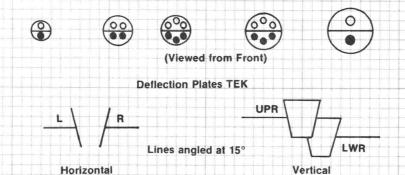
Switchboard Type Connector 5.3.5



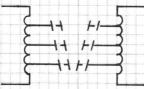
ac Line Plug 5.4



LEMO Connector: Use manufacturers data sheet; some examples are shown here. Do not number the pins on a LEMO connector, as pin numbering on the same type of connector is not consistent.



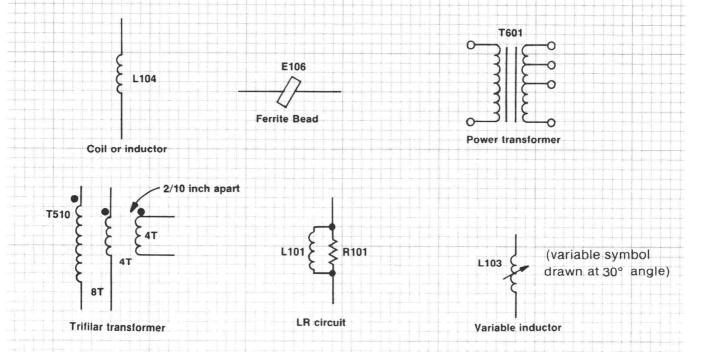
Distributed deflection plates



Transformers and Coils 6.2.1

NOTE: 1. Use four loops for coils and inductors.

2. Eliminate core on transformers except where needed for clarity; e.g., power transformer. Reference 6.1.1.



SEMICONDUCTOR DEVICES 8.1

NOTE: 1. All transistors common to an array will be drawn the same size.

2. Concerning Integrated circuits that consist of one kind of component only, such as transistor arrays, resistor arrays, diode arrays, and the like: Multiple arrays of components that are alike shall bear the reference designation of that unit component. For example, a diode array will bear the class designation letters CR; each unit diode in the array bears the integrated circuit designation plus a suffix letter; e.g., CR1, a four-diode array, consists of CR1A, CR1B, CR1C, and CR1D.

Such units are to be depicted as any other component, except the pin numbers for the integrated circuit should appear on the component leads, as appropriate.

Bridge rectifiers encapsulated as an assembly bear the class designation letters CR.

Single light-emitting diodes are to be designated DS.

The class letter designation U is to be used for seven-segment light-emitting diode arrays, for the following reasons:

- a. These arrays are almost always non-repairable assemblies. (See ANSI Y32.16, paragraphs 3.17 and footnote 7, page 28.)
- b. These arrays often contain elements other than diodes. Thus the designation CR cannot apply.

The above decisions are based on ANSI Y32.16-1968, page 24, paragraph 8.1.

3. Envelopes for semiconductor devices are 13/32, use envelope symbol on template.

Semiconductor Diodes (two terminal devices) 8.5

CR 8.5.1

8.5.2

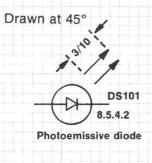
Capacitive diode

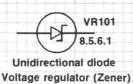
t° 8.5.3

Temperature dependent

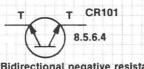
CR 8.5.4.1

Photosensitive diode

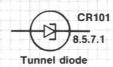


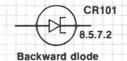






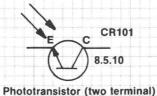
Bidirectional negative resistance breakdown diode; Trigger diac

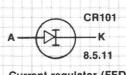






Thyristor, bidirectional diode type; bi-switch

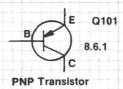




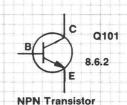
Current regulator (FED)

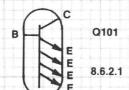
Semiconductor Devices, three or more terminal devices 8.6

NOTE: It is not necessary to label emitter (E), base (B), and collector (C) on common transistors.

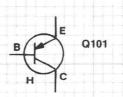


electrode connected to envelope (in this case emitter).

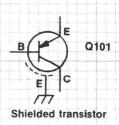


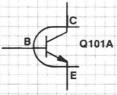


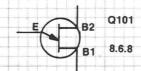
NPN Transistor with multiple emitters (with four emitters shown)

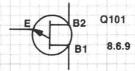


Transistor with heat sink H-Heat sink TEK









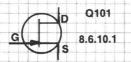
Dual transistor

Unijunction transistor ,
N type base

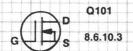
Unijunction transistor,
P type base

Field Effect Transistors (FET)

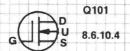
NOTE: Draw the gate opposite the source unless it is known to be otherwise. Label the Gate (G), Drain (D), and the Source (S).



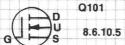
N-Channel junction gate



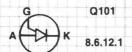
N-Channel insulated gate, depletion-type, single-gate, active-bulk (substrate) internally terminated to source, three-terminal device.



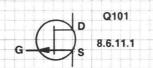
N-Channel insulated gate, depletion-type, single-gate, active-bulk (substrate) externally terminated, four-terminal device.



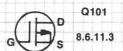
N-Channel insulated-gate, enhancementtype, single-gate, active-bulk (substrate) externally terminated, four-terminal device.



Thyristor, reverse-blocking triode-type, N-type gate; semiconductor controlled rectifier, N-type gate.



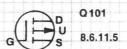
P-Channel junction gate



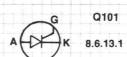
P-Channel insulated-gate, depletion-type, single-gate, active-bulk (substrate) internally terminated to source, three-terminal device.



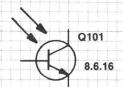
P-Channel insulated-gate, depletion-type, single-gate, active-bulk (substrate) externally terminated, four-terminal device.



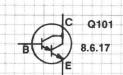
P-Channel insulated-gate, enhancement type, single-gate, active-bulk (substrate) externally terminated, four-terminal device.



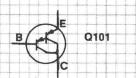
Thyristor, reverse-blocking triode type, P-type gate; semiconductor controlled rectifier, P-type gate.



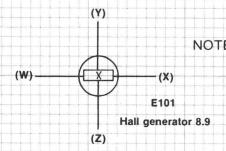
Phototransistor



Darlington transistor NPN-type

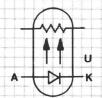


Darlington transistor PNP-type

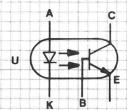


NOTE: W and X are the current terminals; Y and Z are the voltage output terminals. The letters are for explanation and are not part of the symbol.

Photo-Coupled Isolator 8.10



Photoemissive diode and symmetrical photoconductive transducer



Photoemissive diode and phototransistor.

Circuit Protectors 9.1



Fuse F101



Spark gap 9.3 E102



Lamps and Visual Signaling Devices 11.1

DS112 11.2.7 Indicating light.

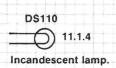
Use this symbol for lamps in general except graticule illumination and non-incandescent lamps such as glow lamps, LEDs, etc.

> PAGE OF

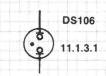
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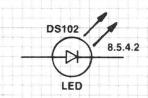
Incandescent lamp.
Use for graticule illumination.



Glow lamp, ac type (Neon)



Glow lamp, dc type (Neon)



Meter, Instrument 12.1

Rotating Machine 13.1

| IV | 110 | ' |
|----|-----|---|
| 1 | | • |
| (| ٧ | |









Generator



Far

Miscellaneous

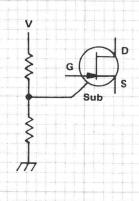
Vcc and Gnd Chart sample

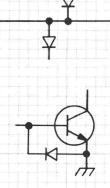
| TYPE | V + +5 V | V - -5 V | V _{DD} +5 V | V _{SS} GND | V _{CC} +5 V | GND | UNUSED PINS -5 V |
|------|-------------|-------------|-------------------------|------------------------|-------------------------|-----|---------------------|
| 741 | 7 | 4 | | | | | |
| 1458 | 8 | 4 | | | | | |
| 4016 | | | 14 | 7 | | | 1,2,13 |
| 7400 | | | | | 14 | 7 | |

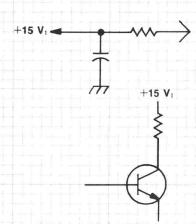


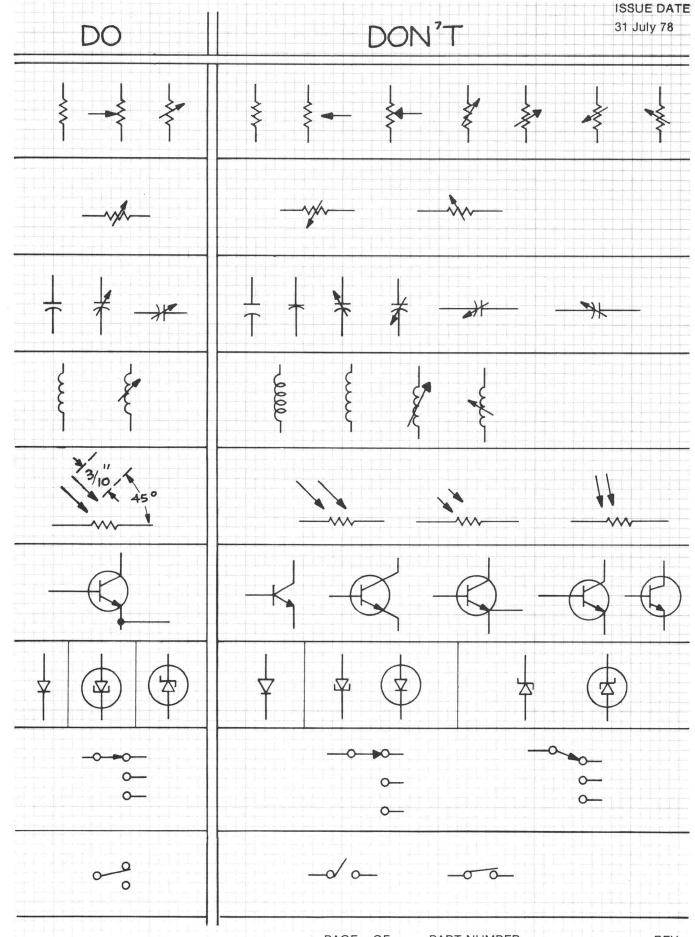
Protective Diode Clamp

Use subscript to indicate decoupled voltages.









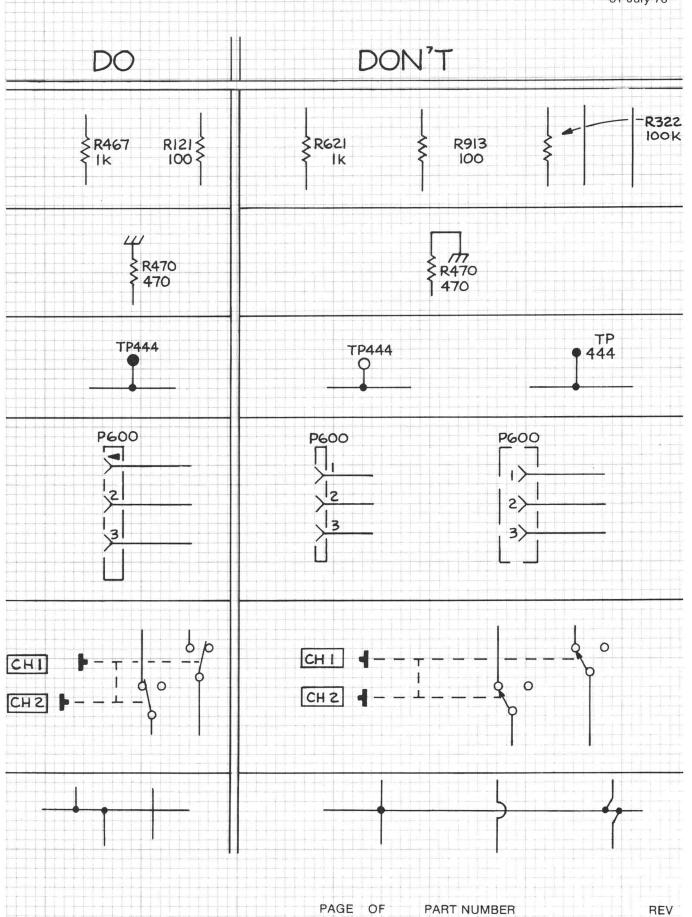
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